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## Product Change Notification - JAON-04DPIS550 (Printer Friendly)

**Date:** 12 Feb 2016  
**Product Category:** Radio Frequency Devices  
**Notification subject:** CCB 2515 Final Notice: Qualification of JEDEC tray and Packing Changes for RN4677, BM77SPPSx, BM78SPPSx, BM70BLES1 Modules.  
**Notification text:** **PCN Status:**  
Final notification

### Microchip Parts Affected:

Please open the attachments found in the attachments field below labeled as PCN\_#\_Affected\_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

### Description of Change:

Qualification of JEDEC tray and Packing Changes for RN4677, BM77SPPSx, BM78SPPSx, BM70BLES1 Modules.

Note: Please review the attached document for pre and post details of the changes.

### Pre Change:

Transparent Tray

### Post Change:

JEDEC standard Tray

### Pre and Post Change Summary:

	Pre Change - Transparent Tray	Post Change - JEDEC standard Tray
<b>Tray Color</b>	Transparent / Clear	Black
<b>No. of modules per tray</b>	60 modules per tray	88 modules per tray
<b>Base Quantity Multiple (BQM) / Minimum Order Quantity</b>	60 modules	88 modules
<b>Tray Dimensions (WxLxH)</b>	206 x 330 x 8 mm	135.9 x 322.6 x 7.62 mm
<b>Inner Box Dimensions</b>	37.5 x 27.0 x 16.5 cm	37.1 x 16.2 x 8.8 cm
<b>Outer Box Dimensions</b>	58.4 x 38.7 x 38.4 cm	39.2 x 34.4 x 19.5 cm
<b>Tray Material</b>	PET	PPE
<b>Tray Thickness</b>	0.5 mm	2 mm

Bakable @150 C, max	NO	YES
Tray matrix	5x12	8x11
Tray Pocket	60	88
Quantity of Trays Per Stack	5+1	10+1
Quantity of Stack Trays per MBB	1	1
Quantity of MBB per Inner Box	4	1
Total Modules in each MBB	300	880
Total Modules in each inner box	1200	880
Inner Box in each Carton	4	4
Total Modules in each Carton	4800	3520
Std Qty per Media	60	88

**Impacts to Data Sheet:**

None

**Reason for Change:**

To improve manufacturability and qualify JEDEC standard tray.

**Change Implementation Status:**

In Progress

**Estimated First Ship Date:**

February 29, 2016 (date code: 1609)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

**Summary Table:**

WW	February 2016				
	05	06	07	08	09
Qual Report Availability		X			
Final PCN Issue Date		X			
Implementation Date					X

**Markings to Distinguish Revised from Unrevised Devices:**  
Traceability code

**Revision History:**  
**February 12, 2016:** Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

- Attachment(s):**
- [CCB 2515 Tray Packing Change Module Products.pdf](#)
  - [PCN\\_JAON-04DPIS550\\_Qual\\_Report.pdf](#)
  - [PCN\\_JAON-04DPIS550\\_Affected\\_CPN.pdf](#)
  - [PCN\\_JAON-04DPIS550\\_Affected\\_CPN.xls](#)

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